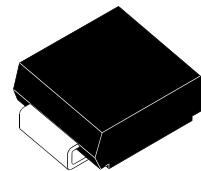


**SMBYT03**

## FAST RECOVERY RECTIFIER DIODES

### FEATURES

- VERY LOW REVERSE RECOVERY TIME
- VERY LOW SWITCHING LOSSES
- LOW NOISE TURN-OFF SWITCHING
- SURFACE MOUNT DEVICE

**SMC**

### DESCRIPTION

Single high voltage rectifier ranging from 200V to 400 V suited for Switch Mode Power Supplies and other power converters.

### ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
$I_{F(RMS)}$	RMS forward current	10	A
$I_{F(AV)}$	Average forward current	3	A
$I_{FSM}$	Non repetitive surge peak forward current	60	A
$T_{stg}$ $T_j$	Storage and junction temperature range	- 40 to + 150 - 40 to + 150	°C °C

Symbol	Parameter	Value	Unit
$V_{RRM}$	Repetitive peak reverse voltage	400	V

### THERMAL RESISTANCE

Symbol	Parameter	Value	Unit
$R_{th} (j-l)$	Junction-leads	20	°C/W

## SMBYT03

### ELECTRICAL CHARACTERISTICS STATIC CHARACTERISTICS

Symbol	Test Conditions		Min.	Typ.	Max.	Unit
$V_F$ *	$T_j = 25^\circ C$	$I_F = 3 A$			1.5	V
	$T_j = 100^\circ C$			1.05	1.4	
$I_R$ **	$T_j = 25^\circ C$	$V_R = V_{RRM}$			10	$\mu A$
	$T_j = 100^\circ C$			0.2	0.6	mA

Pulse test : \* tp = 380  $\mu s$ , duty cycle < 2 %

\*\* tp = 5 ms, duty cycle < 2 %

### RECOVERY CHARACTERISTICS

Symbol	Test Conditions		Min.	Typ.	Max.	Unit
trr	$T_j = 25^\circ C$	$I_F = 0.5 A$	$I_{rr} = 0.25 A$		25	ns
		$I_F = 1 A$	$V_R = 30 V$		60	

### TURN-OFF SWITCHING CHARACTERISTICS (Without serie inductance)

Symbol	Test Conditions			Min.	Typ.	Max.	Unit
$t_{IRM}$	$V_{CC} = 200 V$	$I_F = 3 A$	$L_p \leq 0.05 \mu H$		35	50	ns
$I_{RM}$	$T_j = 100^\circ C$	$dI_F/dt = -50 A/\mu s$			1.5	2	A

To evaluate the conduction losses use the following equation :

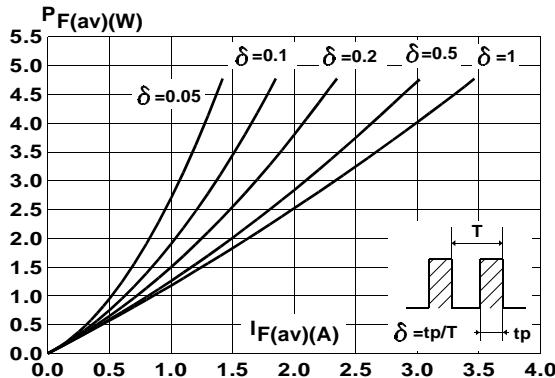
$$P = 1.1 \times I_{F(AV)} + 0.08 \times I_{F^2(RMS)}$$

<b>Voltage (V)</b>	200	300	400
<b>Marking</b>	C2	C3	C4

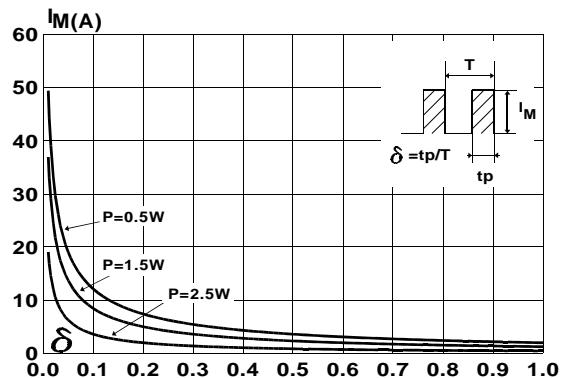
Laser marking

Logo indicates cathode

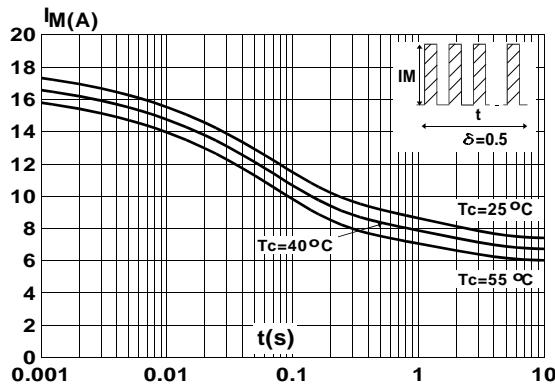
**Fig.1** : Low frequency power losses versus average current.



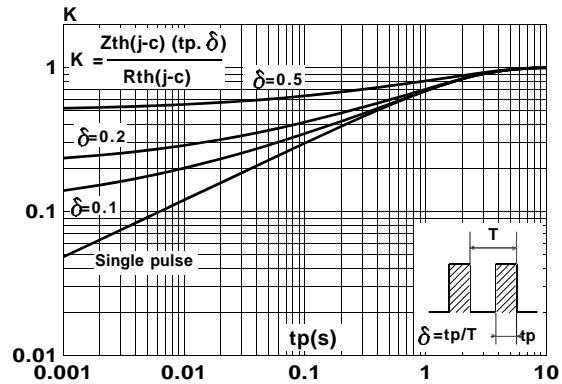
**Fig.2** : Peak current versus form factor.



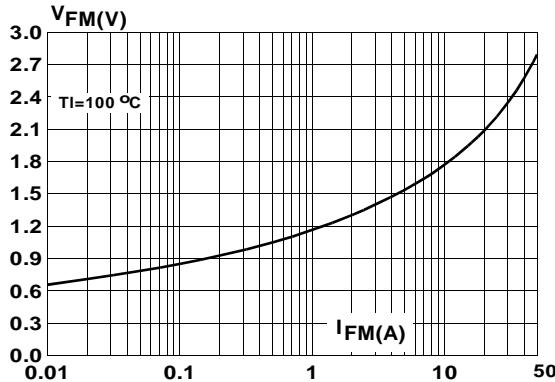
**Fig.3** : Non repetitive surge peak forward current versus overload duration.



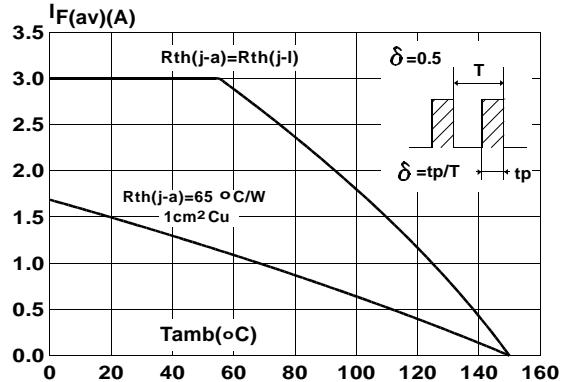
**Fig.4** : Relative variation of thermal impedance junction to lead versus pulse duration.



**Fig.5** : Voltage drop versus forward current. (Maximum values)

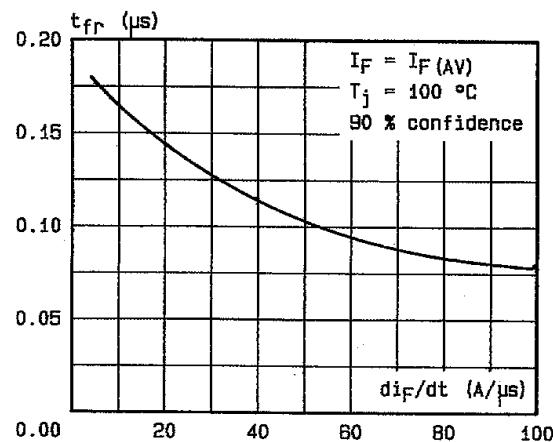


**Fig.6** : Average current versus ambient temperature. (duty cycle : 0.5)

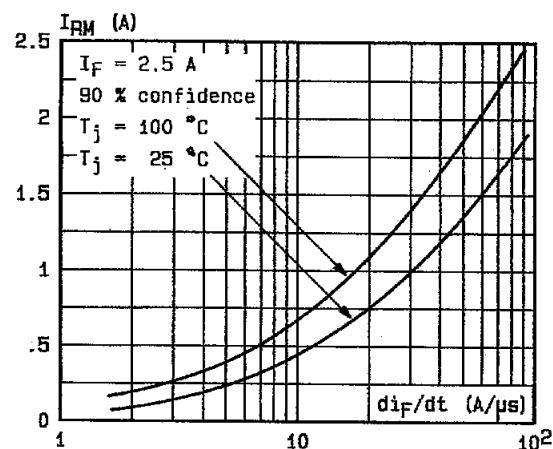


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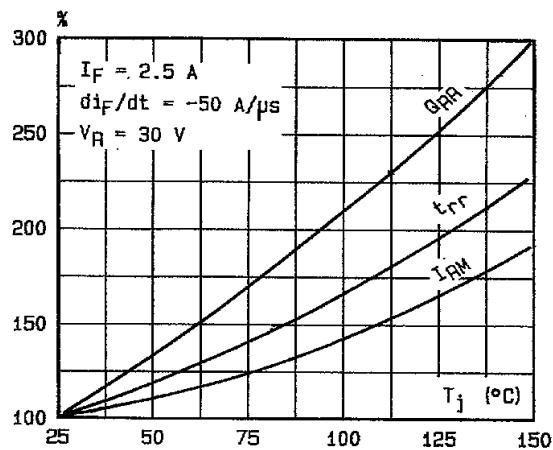
**Fig.7 :** Recovery time versus  $dI_F/dt$ .



**Fig.9 :** Peak reverse current versus  $dI_F/dt$ .

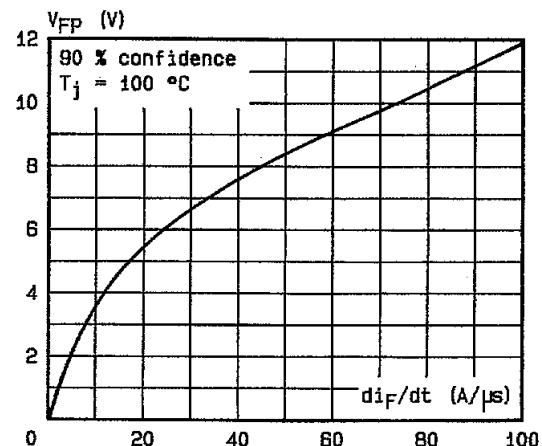


**Fig.11 :** Dynamic parameters versus junction temperature.

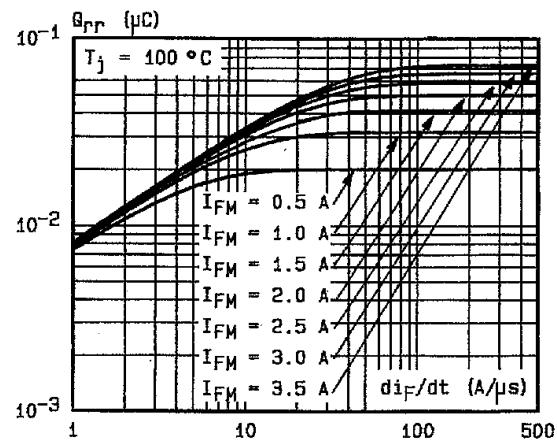


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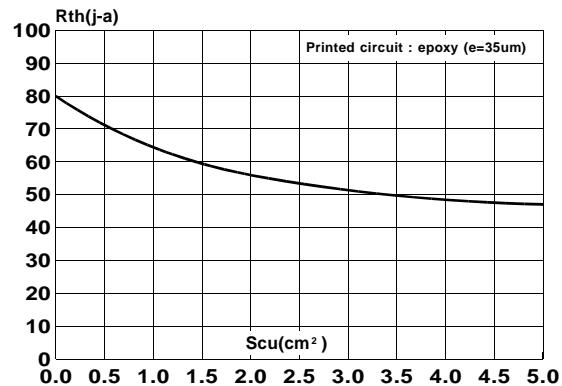
**Fig.8 :** Peak forward voltage versus  $dI_F/dt$ .



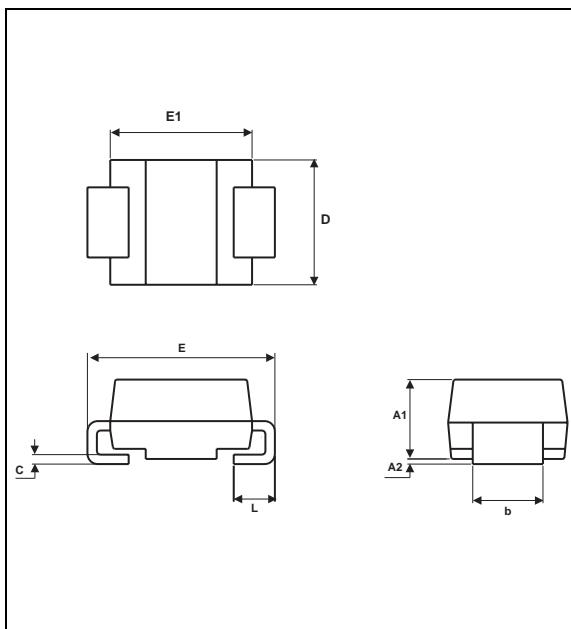
**Fig.10 :** Recovery charge versus  $dI_F/dt$ . (typical values)



**Fig.12 :** Thermal resistance junction to ambient versus copper surface under each lead.

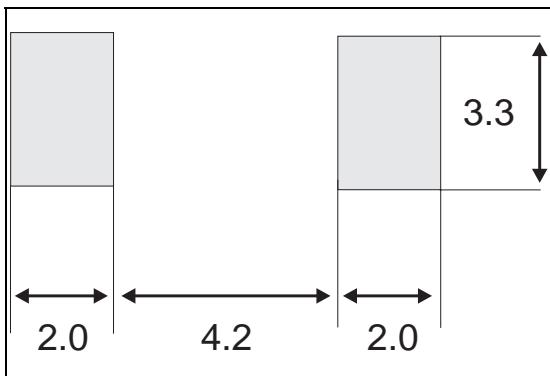


**PACKAGE MECHANICAL DATA**  
SMC



REF.	DIMENSIONS			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A1	1.90	2.45	0.075	0.096
A2	0.05	0.20	0.002	0.008
b	2.90	3.2	0.114	0.126
c	0.15	0.41	0.006	0.016
E	7.75	8.15	0.305	0.321
E1	6.60	7.15	0.260	0.281
E2	4.40	4.70	0.173	0.185
D	5.55	6.25	0.218	0.246
L	0.75	1.60	0.030	0.063

**FOOTPRINT DIMENSIONS**  
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